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FDC638P

P-Channel 2.5V PowerTrench[®] Specified MOSFET

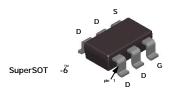
General Description

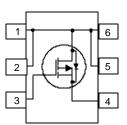
This PChannel 2.5V specified MOSFET is produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance

These devices are well suited for battery power applications: load switching and power management, battery charging circuits, and DC/DC conversion.

Features

- -4.5 A, -20 V. $R_{DS(ON)}$ = 48 m Ω @ V_{GS} = -4.5 V $R_{DS(ON)}$ = 65 m Ω @ V_{GS} = -2.5 V
- Low gate charge (10 nC typical)
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- SuperSOT [™] –6 package: small footprint (72% smaller than standard SO-8; low profile (1mm thick)





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
lь	Drain Current – Continuous	(Note 1a)	-4.5	A
	- Pulsed		-20	
PD	Power Dissipation for Single Operation	(Note 1a)	1.6	W
		(Note 1b)	0.8	VV
T _J , T _{STG}	Operating and Storage Junction Temperat	ure Range	-55 to +150	°C
Therma	I Characteristics			
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
.638	FDC638P	7"	8mm	3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	racteristics			1		I
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}, \text{Referenced to } 25^\circ\text{C}$		-14		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 V$, $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)			•		•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-0.8	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		3		mV/ºC
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = -4.5 \ V, & I_D = -4.5 \ A \\ V_{GS} = -2.5 \ V, & I_D = -3.8 \ A \\ V_{GS} = -4.5 \ V, & I_D = -4.5 \ T_J = 125^\circ C \end{array} $		39 52 54	48 65 72	mΩ
D(on)	On–State Drain Current	$V_{GS} = -4.5 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-20			Α
g _{FS}	Forward Transconductance	$V_{DS} = -10 V$, $I_D = -4.5 A$		15		S
Dvnamio	c Characteristics	· · ·				
Ciss	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		1160		pF
Coss	Output Capacitance	f = 1.0 MHz		195		pF
Crss	Reverse Transfer Capacitance	7		105		pF
Switchir	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time			12	22	ns
tr	Turn–On Rise Time			9	18	ns
t _{d(off)}	Turn–Off Delay Time			33	53	ns
t _f	Turn–Off Fall Time			12	22	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -4.5 A$,		10	14	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		2.2		nC
Q _{gd}	Gate–Drain Charge			1.5		nC
Drain-S	ource Diode Characteristics a	and Maximum Ratings				
	Maximum Continuous Drain–Source Diode Forward Current				-1.3	Α
s	Drain-Source Diode Forward	$V_{GS} = 0 V$, $I_S = -1.3 A$ (Note 2)		-0.73	-1.2	V



a) 78°C/W when mounted on a 1in² pad of 2 oz copper

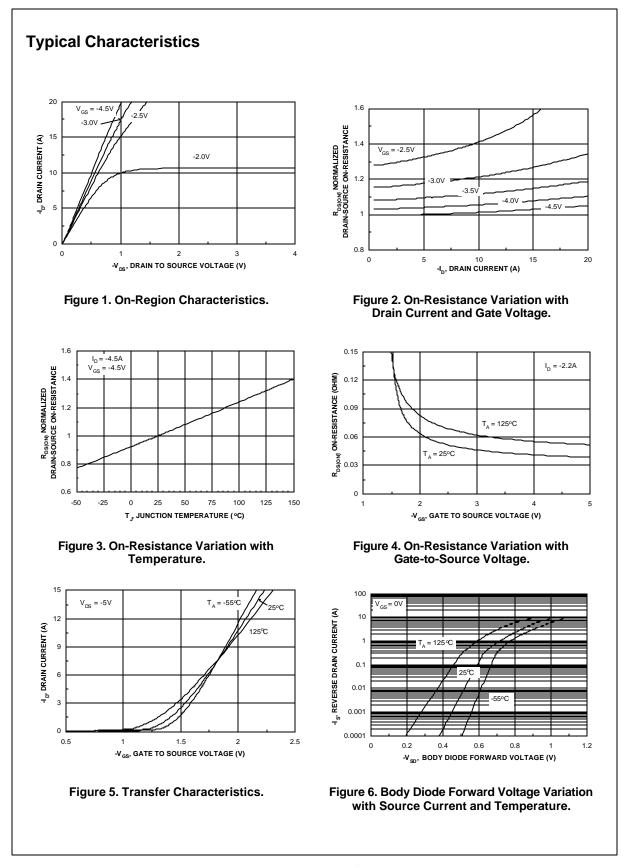


156°C/W when mounted on a minimum pad of 2 oz copper

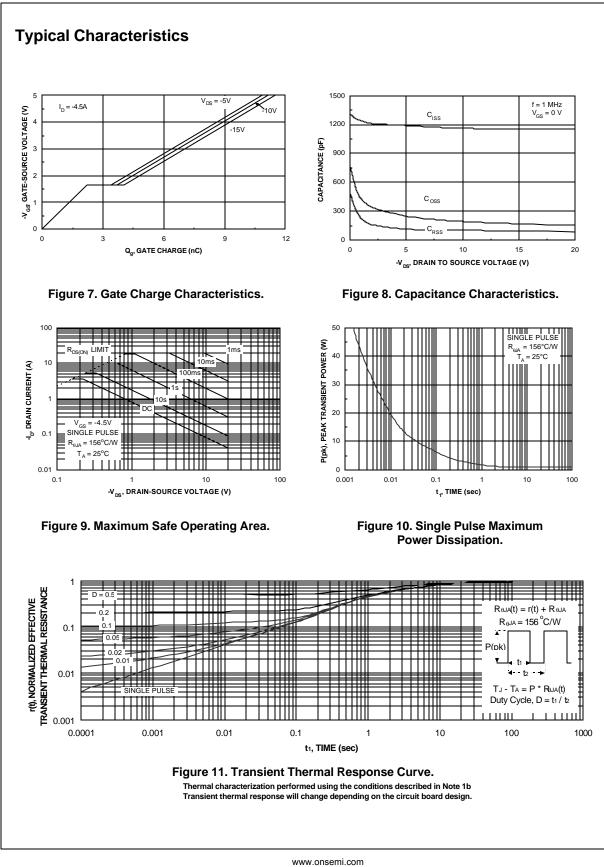
b)

Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width < $300\mu s,$ Duty Cycle < 2.0%

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